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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

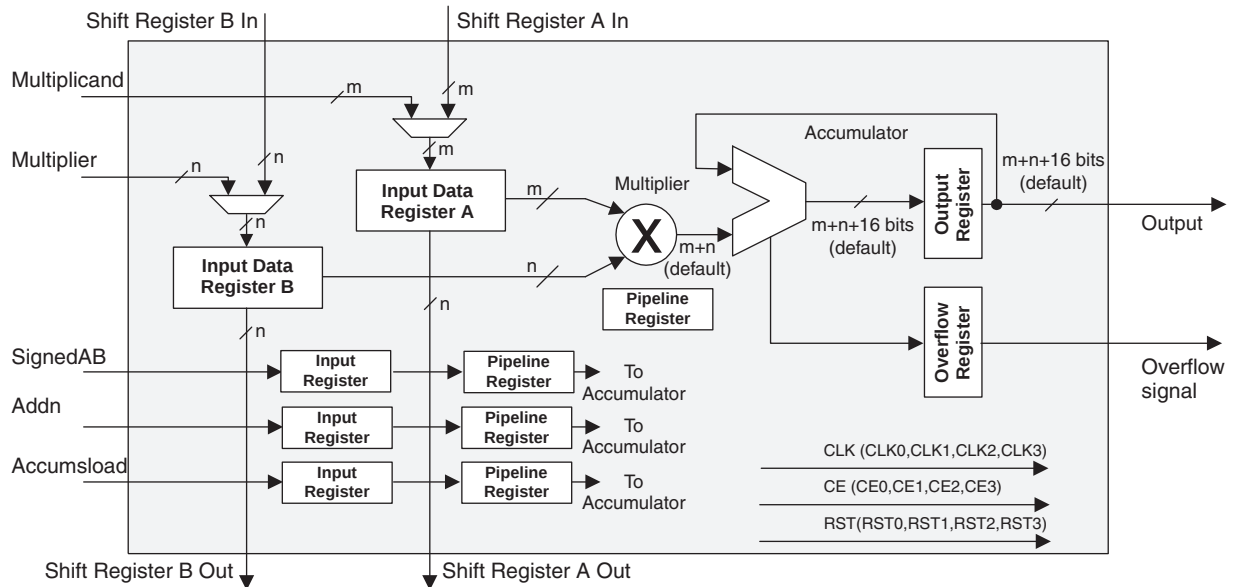
Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	10200
Total RAM Bits	282624
Number of I/O	147
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	208-BFQFP
Supplier Device Package	208-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfec10e-3qn208c

Figure 2-20. MAC sysDSP Element



MULTADD sysDSP Element

In this case, the operands A0 and B0 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A1 and A2. The user can enable the input, output and pipeline registers. Figure 2-21 shows the MULTADD sysDSP element.

Figure 2-21. MULTADD

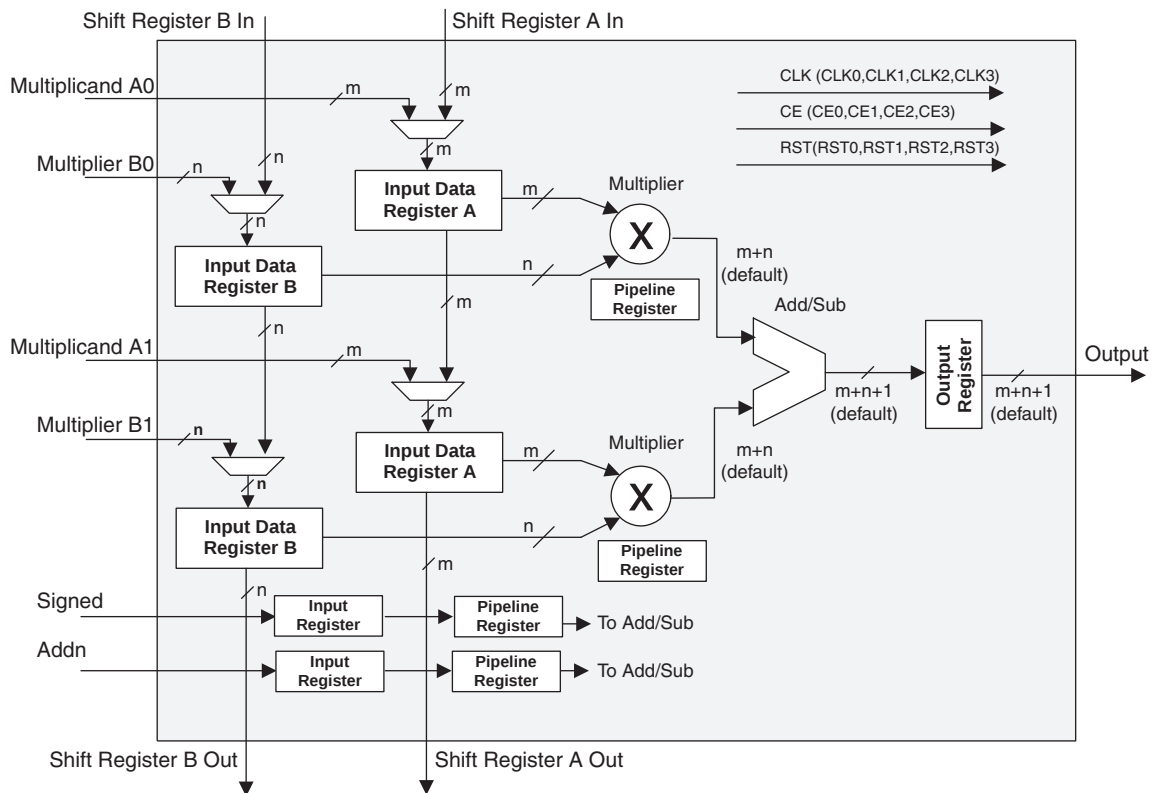


Figure 2-27. Input Register DDR Waveforms

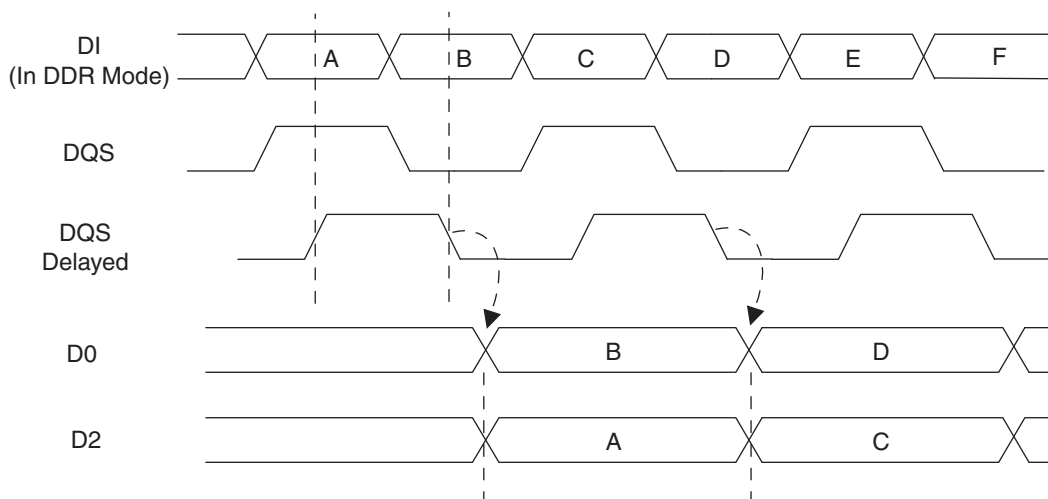
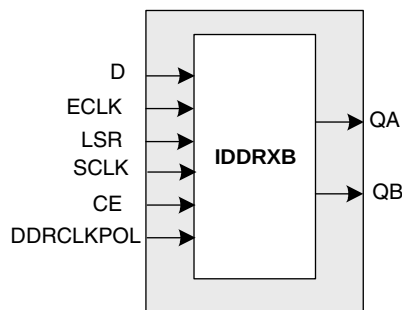


Figure 2-28. INDDRxB Primitive



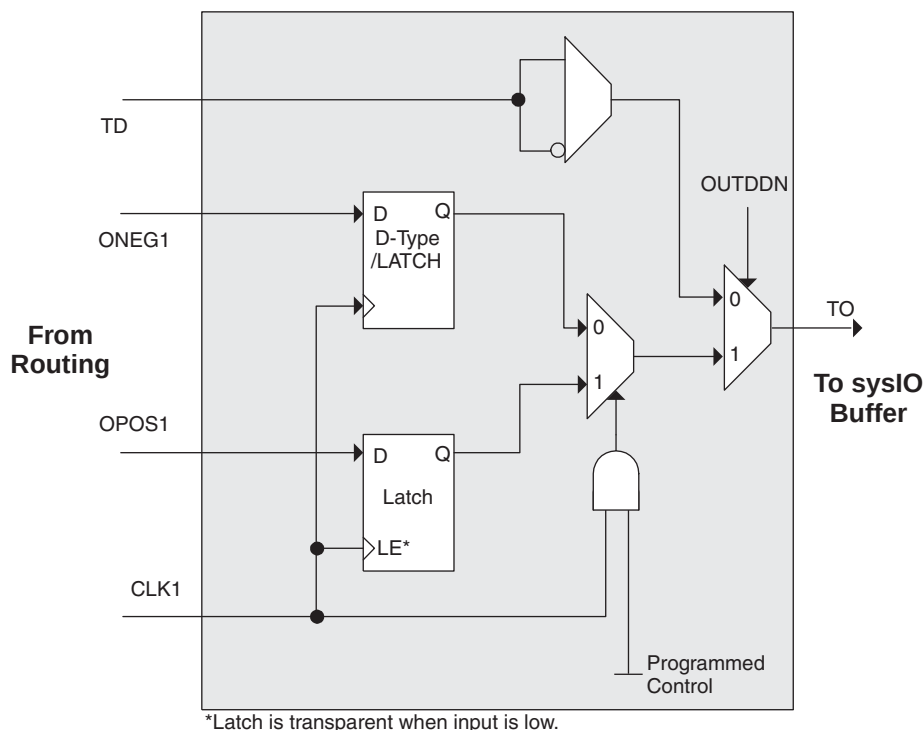
Output Register Block

The output register block provides the ability to register signals from the core of the device before they are passed to the sysI/O buffers. The block contains a register for SDR operation that is combined with an additional latch for DDR operation. Figure 2-29 shows the diagram of the Output Register Block.

In SDR mode, ONEG0 feeds one of the flip-flops that then feeds the output. The flip-flop can be configured a D-type or latch. In DDR mode, ONEG0 is fed into one register on the positive edge of the clock and OPOS0 is latched. A multiplexer running off the same clock selects the correct register for feeding to the output (D0).

Figure 2-30 shows the design tool DDR primitives. The SDR output register has reset and clock enable available. The additional register for DDR operation does not have reset or clock enable available.

Figure 2-31. Tristate Register Block



Control Logic Block

The control logic block allows the selection and modification of control signals for use in the PIO block. A clock is selected from one of the clock signals provided from the general purpose routing and a DQS signal provided from the programmable DQS pin. The clock can optionally be inverted.

The clock enable and local reset signals are selected from the routing and optionally inverted. The global tristate signal is passed through this block.

DDR Memory Support

Implementing high performance DDR memory interfaces requires dedicated DDR register structures in the input (for read operations) and in the output (for write operations). As indicated in the PIO Logic section, the LatticeEC devices provide this capability. In addition to these registers, the LatticeEC devices contain two elements to simplify the design of input structures for read operations: the DQS delay block and polarity control logic.

DLL Calibrated DQS Delay Block

Source Synchronous interfaces generally require the input clock to be adjusted in order to correctly capture data at the input register. For most interfaces a PLL is used for this adjustment. However in DDR memories the clock (referred to as DQS) is not free running so this approach cannot be used. The DQS Delay block provides the required clock alignment for DDR memory interfaces.

The DQS signal (selected PIOs only) feeds from the PAD through a DQS delay element to a dedicated DQS routing resource. The DQS signal also feeds polarity control logic, which controls the polarity of the clock to the sync registers in the input register blocks. Figures 2-32 and 2-33 show how the DQS transition signals are routed to the PIOs.

The temperature, voltage and process variations of the DQS delay block are compensated by a set of calibration (6-bit bus) signals from two DLLs on opposite sides of the device. Each DLL compensates DQS Delays in its half of the device as shown in Figure 2-33. The DLL loop is compensated for temperature, voltage and process variations by the system clock and feedback loop.

DC Electrical Characteristics

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{IL}, I_{IH}^1	Input or I/O Leakage	$0 \leq V_{IN} \leq (V_{CCIO} - 0.2V)$	—	—	10	μA
$I_{IH}^{1,3}$	Input or I/O High Leakage	$(V_{CCIO} - 0.2V) \leq V_{IH} \leq 3.6V$	—	—	40	μA
I_{PU}	I/O Active Pull-up Current	$0 \leq V_{IN} \leq 0.7 V_{CCIO}$	-30	—	-150	μA
I_{PD}	I/O Active Pull-down Current	$V_{IL} (MAX) \leq V_{IN} \leq V_{IH} (MAX)$	30	—	150	μA
I_{BHLS}	Bus Hold Low sustaining current	$V_{IN} = V_{IL} (MAX)$	30	—	—	μA
I_{BHHS}	Bus Hold High sustaining current	$V_{IN} = 0.7V_{CCIO}$	-30	—	—	μA
I_{BHLO}	Bus Hold Low Overdrive current	$0 \leq V_{IN} \leq V_{IH} (MAX)$	—	—	150	μA
I_{BHLH}	Bus Hold High Overdrive current	$0 \leq V_{IN} \leq V_{IH} (MAX)$	—	—	-150	μA
V_{BHT}	Bus Hold trip Points	$0 \leq V_{IN} \leq V_{IH} (MAX)$	$V_{IL} (MAX)$	—	$V_{IH} (MIN)$	V
C1	I/O Capacitance ²	$V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V,$ $V_{CC} = 1.2V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$	—	8	—	pf
C2	Dedicated Input Capacitance ²	$V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V,$ $V_{CC} = 1.2V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$	—	6	—	pf

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.

2. T_A 25°C, $f = 1.0MHz$

3. For top and bottom general purpose I/O pins, when V_{IH} is higher than V_{CCIO} , a transient current typically of 30ns in duration or less with a peak current of 6mA can occur on the high-to-low transition. For left and right I/O banks, V_{IH} must be less than or equal to V_{CCIO} .

sysI/O Single-Ended DC Electrical Characteristics

Input/Output Standard	V_{IL}		V_{IH}		V_{OL} Max. (V)	V_{OH} Min. (V)	I_{OL}^1 (mA)	I_{OH}^1 (mA)
	Min. (V)	Max. (V)	Min. (V)	Max. (V)				
LVCMOS 3.3	-0.3	0.8	2.0	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVTTTL	-0.3	0.8	2.0	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 2.5	-0.3	0.7	1.7	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.8	-0.3	$0.35V_{CCIO}$	$0.65V_{CCIO}$	3.6	0.4	$V_{CCIO} - 0.4$	16, 12, 8, 4	-16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.5	-0.3	$0.35V_{CCIO}$	$0.65V_{CCIO}$	3.6	0.4	$V_{CCIO} - 0.4$	8, 4	-8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.2	-0.3	$0.35V_{CC}$	$0.65V_{CC}$	3.6	0.4	$V_{CCIO} - 0.4$	6, 2	-6, -2
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
PCI	-0.3	$0.3V_{CCIO}$	$0.5V_{CCIO}$	3.6	$0.1V_{CCIO}$	$0.9V_{CCIO}$	1.5	-0.5
SSTL3 class I	-0.3	$V_{REF} - 0.2$	$V_{REF} + 0.2$	3.6	0.7	$V_{CCIO} - 1.1$	8	-8
SSTL3 class II	-0.3	$V_{REF} - 0.2$	$V_{REF} + 0.2$	3.6	0.5	$V_{CCIO} - 0.9$	16	-16
SSTL2 class I	-0.3	$V_{REF} - 0.18$	$V_{REF} + 0.18$	3.6	0.54	$V_{CCIO} - 0.62$	7.6	-7.6
SSTL2 class II	-0.3	$V_{REF} - 0.18$	$V_{REF} + 0.18$	3.6	0.35	$V_{CCIO} - 0.43$	15.2	-15.2
SSTL18 class I	-0.3	$V_{REF} - 0.125$	$V_{REF} + 0.125$	3.6	0.4	$V_{CCIO} - 0.4$	6.7	-6.7
HSTL15 class I	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	8	-8
HSTL15 class III	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	24	-8
HSTL18 class I	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	9.6	-9.6
HSTL18 class II	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	16	-16
HSTL18 class III	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	24	-8

1. The average DC current drawn by I/Os between GND connections, or between the last GND in an I/O bank and the end of an I/O bank, as shown in the logic signal connections table shall not exceed $n * 8\text{mA}$. Where n is the number of I/Os between bank GND connections or between the last GND in a bank and the end of a bank.

sysI/O Differential Electrical Characteristics

LVDS

Over Recommended Operating Conditions

Parameter Symbol	Parameter Description	Test Conditions	Min.	Typ.	Max.	Units
V_{INP}, V_{INM}	Input voltage		0	—	2.4	V
V_{THD}	Differential input threshold		+/-100	—	—	mV
V_{CM}	Input common mode voltage	100mV δV_{THD}	$V_{THD}/2$	1.2	1.8	V
		200mV δV_{THD}	$V_{THD}/2$	1.2	1.9	V
		350mV δV_{THD}	$V_{THD}/2$	1.2	2.0	V
I_{IN}	Input current	Power on or power off	—	—	+/-10	μA
V_{OH}	Output high voltage for V_{OP} or V_{OM}	$R_T = 100 \text{ Ohm}$	—	1.38	1.60	V
V_{OL}	Output low voltage for V_{OP} or V_{OM}	$R_T = 100 \text{ Ohm}$	0.9V	1.03	—	V
V_{OD}	Output voltage differential	$(V_{OP} - V_{OM}), R_T = 100 \text{ Ohm}$	250	350	450	mV
ΔV_{OD}	Change in V_{OD} between high and low		—	—	50	mV
V_{OS}	Output voltage offset	$(V_{OP} + V_{OM})/2, R_T = 100 \text{ Ohm}$	1.125	1.25	1.375	V
ΔV_{OS}	Change in V_{OS} between H and L		—	—	50	mV
I_{OSD}	Output short circuit current	$V_{OD} = 0V$ Driver outputs shorted	—	—	6	mA

BLVDS

The LatticeECP/EC devices support BLVDS standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel external resistor across the driver outputs. BLVDS is intended for use when multi-drop and bi-directional multi-point differential signaling is required. The scheme shown in Figure 3-2 is one possible solution for bi-directional multi-point differential signals.

Figure 3-2. BLVDS Multi-point Output Example

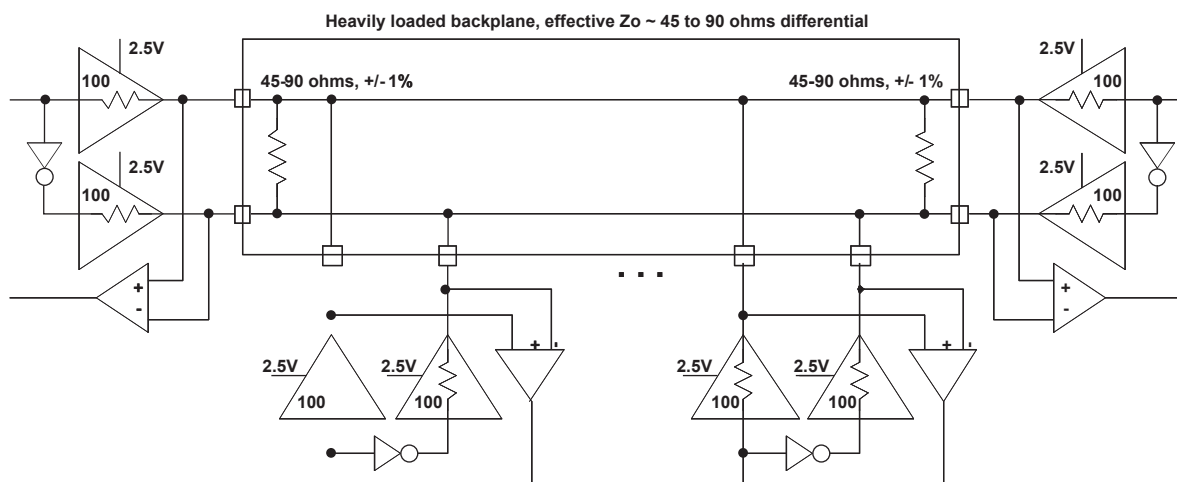


Table 3-2. BLVDS DC Conditions¹

Over Recommended Operating Conditions

Parameter	Description	Typical		Units
		Zo = 45	Zo = 90	
Z _{OUT}	Output impedance	100	100	ohm
R _{TLEFT}	Left end termination	45	90	ohm
R _{TRIGHT}	Right end termination	45	90	ohm
V _{OH}	Output high voltage	1.375	1.48	V
V _{OL}	Output low voltage	1.125	1.02	V
V _{OD}	Output differential voltage	0.25	0.46	V
V _{CM}	Output common mode voltage	1.25	1.25	V
I _{DC}	DC output current	11.2	10.2	mA

1. For input buffer, see LVDS table.

LatticeECP/EC sysCONFIG Port Timing Specifications (Continued)

Over Recommended Operating Conditions

Parameter	Description	Min.	Typ.	Max.	Units
t_{SOE}	CSSPIN Active Setup Time	300		—	ns
t_{CSPID}	CSSPIN Low to First Clock Edge Setup Time	300+3cyc		600+6cyc	ns
f_{MAXSPI}	Max Frequency for SPI	—		25	MHz
t_{SUSPI}	SOSPI Data Setup Time Before CCLK	7		—	ns
t_{HSPI}	SOSPI Data Hold Time After CCLK	1		—	ns

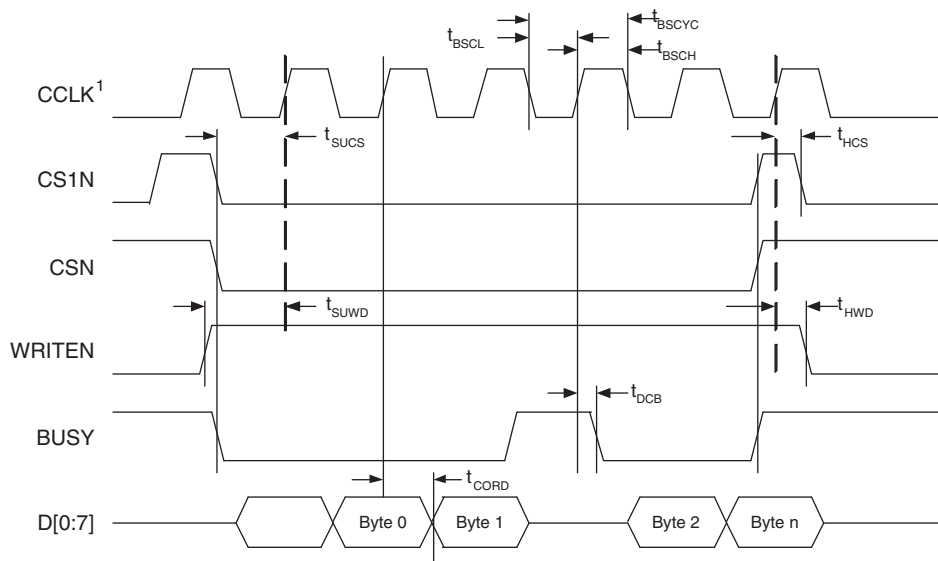
Timing v.G 0.30

Master Clock

Clock Mode	Min.	Typ.	Max.	Units
2.5MHz	1.75	2.5	3.25	MHz
5 MHz	3.78	5.4	7.02	MHz
10 MHz	7	10	13	MHz
15 MHz	10.5	15	19.5	MHz
20 MHz	14	20	26	MHz
25 MHz	18.2	26	33.8	MHz
30 MHz	21	30	39	MHz
35 MHz	23.8	34	44.2	MHz
40 MHz	28.7	41	53.3	MHz
45 MHz	31.5	45	58.5	MHz
50 MHz	35.7	51	66.3	MHz
55 MHz	38.5	55	71.5	MHz
60 MHz	42	60	78	MHz
Duty Cycle	40	—	60	%

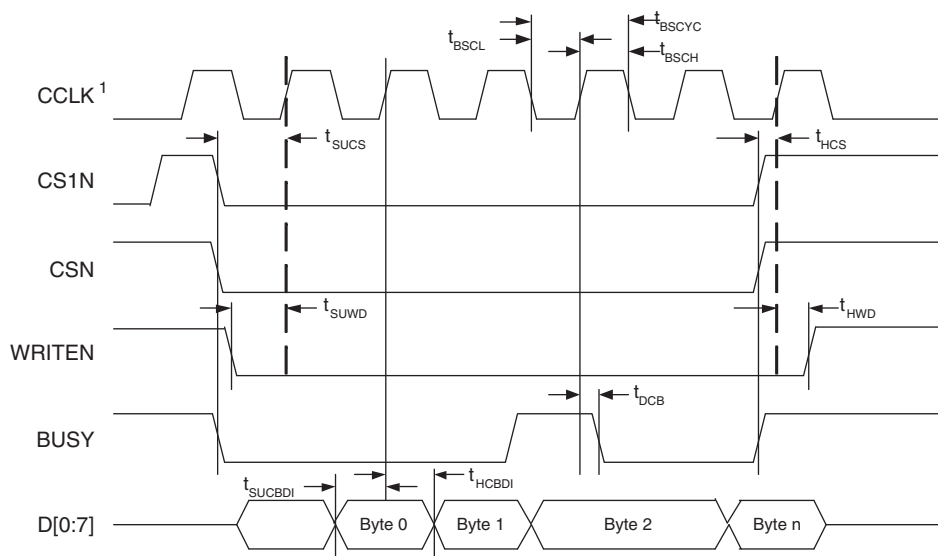
Timing v.G 0.30

Figure 3-12. sysCONFIG Parallel Port Read Cycle



1. In Master Parallel Mode the FPGA provides CCLK. In Slave Parallel Mode the external device provides CCLK.

Figure 3-13. sysCONFIG Parallel Port Write Cycle



1. In Master Parallel Mode the FPGA provides CCLK. In Slave Parallel Mode the external device provides CCLK.

LFEC1, LFEC3 Logic Signal Connections: 208 PQFP (Cont.)

Pin Number	LFEC1				LFEC3			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
43	PL11A	6	T	LDQS11	PL15A	6	T	LDQS15
44	PL11B	6	C		PL15B	6	C	
45	PL12A	6	T		PL16A	6	T	
46	PL12B	6	C		PL16B	6	C	
47	PL13A	6	T		PL17A	6	T	
48	PL13B	6	C		PL17B	6	C	
49	PL14A	6	T	VREF1_6	PL18A	6	T	VREF1_6
50	PL14B	6	C	VREF2_6	PL18B	6	C	VREF2_6
51	VCCIO6	6			VCCIO6	6		
52*	GND5 GND6	-			GND5 GND6	-		
53	VCCIO5	5			VCCIO5	5		
54	NC	-			PB2A	5	T	
55	NC	-			PB2B	5	C	
56	NC	-			PB3A	5	T	
57	NC	-			PB3B	5	C	
58	NC	-			PB4A	5	T	
59	NC	-			PB4B	5	C	
60	NC	-			PB5A	5	T	
61	NC	-			PB5B	5	C	
62	NC	-			PB6A	5	T	BDQS6
63	NC	-			PB6B	5	C	
64	NC	-			VCCIO5	5		
65	PB2A	5	T		PB10A	5	T	
66	PB2B	5	C		PB10B	5	C	
67	PB3A	5	T		PB11A	5	T	
68	PB3B	5	C		PB11B	5	C	
69	PB4A	5	T		PB12A	5	T	
70	PB4B	5	C		PB12B	5	C	
71	PB5A	5	T		PB13A	5	T	
72	NC	-			GND5	5		
73	PB5B	5	C		PB13B	5	C	
74	VCCIO5	5			VCCIO5	5		
75	PB6A	5	T	BDQS6	PB14A	5	T	BDQS14
76	PB6B	5	C		PB14B	5	C	
77	PB7A	5	T		PB15A	5	T	
78	PB7B	5	C		PB15B	5	C	
79	PB8A	5	T	VREF2_5	PB16A	5	T	VREF2_5
80	PB8B	5	C	VREF1_5	PB16B	5	C	VREF1_5
81	PB9A	5	T	PCLKT5_0	PB17A	5	T	PCLKT5_0
82	GND5	5			GND5	5		
83	PB9B	5	C	PCLKC5_0	PB17B	5	C	PCLKC5_0
84	VCCAUX	-			VCCAUX	-		

LFEC1, LFEC3 Logic Signal Connections: 208 PQFP (Cont.)

Pin Number	LFEC1				LFEC3			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
85	VCCIO4	4			VCCIO4	4		
86	PB10A	4	T	WRITEN	PB18A	4	T	WRITEN
87	PB10B	4	C	CS1N	PB18B	4	C	CS1N
88	PB11A	4	T	VREF1_4	PB19A	4	T	VREF1_4
89	PB11B	4	C	CSN	PB19B	4	C	CSN
90	PB12A	4	T	VREF2_4	PB20A	4	T	VREF2_4
91	PB12B	4	C	D0/SPID7	PB20B	4	C	D0/SPID7
92	PB13A	4	T	D2/SPID5	PB21A	4	T	D2/SPID5
93	GND4	4			GND4	4		
94	PB13B	4	C	D1/SPID6	PB21B	4	C	D1/SPID6
95	PB14A	4	T	BDQS14	PB22A	4	T	BDQS22
96	PB14B	4	C	D3/SPID4	PB22B	4	C	D3/SPID4
97	PB15A	4	T		PB23A	4	T	
98	PB15B	4	C	D4/SPID3	PB23B	4	C	D4/SPID3
99	PB16A	4	T		PB24A	4	T	
100	PB16B	4	C	D5/SPID2	PB24B	4	C	D5/SPID2
101	PB17A	4	T		PB25A	4	T	
102	PB17B	4	C	D6/SPID1	PB25B	4	C	D6/SPID1
103	NC	-			NC	-		
104	VCCIO4	4			VCCIO4	4		
105*	GND3 GND4	-			GND3 GND4	-		
106	VCCIO3	3			VCCIO3	3		
107	PR14B	3	C	VREF2_3	PR18B	3	C	VREF2_3
108	PR14A	3	T	VREF1_3	PR18A	3	T	VREF1_3
109	PR13B	3	C		PR17B	3	C	
110	PR13A	3	T		PR17A	3	T	
111	PR12B	3	C		PR16B	3	C	
112	PR12A	3	T		PR16A	3	T	
113	PR11B	3	C		PR15B	3	C	
114	PR11A	3	T	RDQS11	PR15A	3	T	RDQS15
115	PR10B	3	C	RLM0_PLLC_FB_A	PR14B	3	C	RLM0_PLLC_FB_A
116	GND3	3			GND3	3		
117	PR10A	3	T	RLM0_PLLT_FB_A	PR14A	3	T	RLM0_PLLT_FB_A
118	PR9B	3	C	RLM0_PLLC_IN_A	PR13B	3	C	RLM0_PLLC_IN_A
119	PR9A	3	T	RLM0_PLLT_IN_A	PR13A	3	T	RLM0_PLLT_IN_A
120	VCCIO3	3			VCCIO3	3		
121	PR8B	3	C	DI/CSSPIN	PR12B	3	C	DI/CSSPIN
122	PR8A	3	T	DOUT/CSON	PR12A	3	T	DOUT/CSON
123	PR7B	3	C	BUSY/SISPI	PR11B	3	C	BUSY/SISPI
124	PR7A	3	T	D7/SPID0	PR11A	3	T	D7/SPID0
125	CFG2	3			CFG2	3		
126	CFG1	3			CFG1	3		

LFEC1, LFEC3 Logic Signal Connections: 208 PQFP (Cont.)

Pin Number	LFEC1				LFEC3			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
169	PT13A	1	T		PT21A	1	T	
170	PT12B	1	C		PT20B	1	C	
171	PT12A	1	T		PT20A	1	T	
172	PT11B	1	C	VREF2_1	PT19B	1	C	VREF2_1
173	PT11A	1	T	VREF1_1	PT19A	1	T	VREF1_1
174	PT10B	1	C		PT18B	1	C	
175	PT10A	1	T		PT18A	1	T	
176	VCCIO1	1			VCCIO1	1		
177	VCCAUX	-			VCCAUX	-		
178	PT9B	0	C	PCLKC0_0	PT17B	0	C	PCLKC0_0
179	GND0	0			GND0	0		
180	PT9A	0	T	PCLKT0_0	PT17A	0	T	PCLKT0_0
181	PT8B	0	C	VREF1_0	PT16B	0	C	VREF1_0
182	PT8A	0	T	VREF2_0	PT16A	0	T	VREF2_0
183	PT7B	0	C		PT15B	0	C	
184	PT7A	0	T		PT15A	0	T	
185	PT6B	0	C		PT14B	0	C	
186	PT6A	0	T	TDQS6	PT14A	0	T	TDQS14
187	VCCIO0	0			VCCIO0	0		
188	PT5B	0	C		PT13B	0	C	
189	NC	-			GND0	0		
190	PT5A	0	T		PT13A	0	T	
191	PT4B	0	C		PT12B	0	C	
192	PT4A	0	T		PT12A	0	T	
193	PT3B	0	C		PT11B	0	C	
194	PT3A	0	T		PT11A	0	T	
195	PT2B	0	C		PT10B	0	C	
196	PT2A	0	T		PT10A	0	T	
197	NC	-			VCCIO0	0		
198	NC	-			PT6B	0	C	
199	NC	-			PT6A	0	T	TDQS6
200	NC	-			PT5B	0	C	
201	NC	-			PT5A	0	T	
202	NC	-			PT4B	0	C	
203	NC	-			PT4A	0	T	
204	NC	-			PT3B	0	C	
205	NC	-			PT3A	0	T	
206	NC	-			PT2B	0	C	
207	NC	-			PT2A	0	T	
208	VCCIO0	0			VCCIO0	0		

* Double bonded to the pin.

LFEC3 and LFECP/EC6 Logic Signal Connections: 256 fpBGA

Ball Number	LFEC3				LFECP6/LFEC6			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
GND	GND7	7			GND7	7		
D4	PL2A	7	T	VREF2_7	PL2A	7	T	VREF2_7
D3	PL2B	7	C	VREF1_7	PL2B	7	C	VREF1_7
C3	PL3A	7	T		PL3A	7	T	
C2	PL3B	7	C		PL3B	7	C	
B1	PL4A	7	T		PL4A	7	T	
C1	PL4B	7	C		PL4B	7	C	
E3	PL5A	7	T		PL5A	7	T	
E4	PL5B	7	C		PL5B	7	C	
F4	PL6A	7	T	LDQS6	PL6A	7	T	LDQS6
F5	PL6B	7	C		PL6B	7	C	
G4	PL7A	7	T		PL7A	7	T	
G3	PL7B	7	C		PL7B	7	C	
D2	PL8A	7	T		PL8A	7	T	
D1	PL8B	7	C		PL8B	7	C	
E1	PL9A	7	T	PCLKT7_0	PL9A	7	T	PCLKT7_0
GND	GND7	7			GND7	7		
E2	PL9B	7	C	PCLKC7_0	PL9B	7	C	PCLKC7_0
F3	XRES	6			XRES	6		
G5	NC	-			PL11A	6	T	
H5	NC	-			PL11B	6	C	
F2	NC	-			PL12A	6	T	
F1	NC	-			PL12B	6	C	
H4	NC	-			PL13A	6	T	
H3	NC	-			PL13B	6	C	
G2	NC	-			PL14A	6	T	
-	-	-			GND6	6		
G1	NC	-			PL14B	6	C	
J4	NC	-			PL15A	6	T	LDQS15
J3	NC	-			PL15B	6	C	
J5	NC	-			PL16A	6	T	
K5	NC	-			PL16B	6	C	
H2	NC	-			PL17A	6	T	
H1	NC	-			PL17B	6	C	
J2	NC	-			PL18A	6	T	
-	-	-			GND6	6		
J1	NC	-			PL18B	6	C	
K4	TCK	6			TCK	6		
K3	TDI	6			TDI	6		
L3	TMS	6			TMS	6		
L5	TDO	6			TDO	6		
L4	VCCJ	6			VCCJ	6		

LFEC3 and LFECP/EC6 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFEC3				LFECP6/LFEC6			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
N16	PR14A	3	T	RLM0_PLLT_FB_A	PR23A	3	T	RLM0_PLLT_FB_A
N15	PR13B	3	C	RLM0_PLLC_IN_A	PR22B	3	C	RLM0_PLLC_IN_A
M15	PR13A	3	T	RLM0_PLLT_IN_A	PR22A	3	T	RLM0_PLLT_IN_A
M16	PR12B	3	C	DI/CSSPIN	PR21B	3	C	DI/CSSPIN
L16	PR12A	3	T	DOUT/CSON	PR21A	3	T	DOUT/CSON
K16	PR11B	3	C	BUSY/SISPI	PR20B	3	C	BUSY/SISPI
J16	PR11A	3	T	D7/SPID0	PR20A	3	T	D7/SPID0
L12	CFG2	3			CFG2	3		
L14	CFG1	3			CFG1	3		
L13	CFG0	3			CFG0	3		
K13	PROGRAMN	3			PROGRAMN	3		
L15	CCLK	3			CCLK	3		
K15	INITN	3			INITN	3		
K14	DONE	3			DONE	3		
	-	-			GND3	3		
H16	NC	-			PR18B	3	C	
H15	NC	-			PR18A	3	T	
G16	NC	-			PR17B	3	C	
G15	NC	-			PR17A	3	T	
K12	NC	-			PR16B	3	C	
J12	NC	-			PR16A	3	T	
J14	NC	-			PR15B	3	C	
J15	NC	-			PR15A	3	T	RDQS15
F16	NC	-			PR14B	3	C	
-	-	-			GND3	3		
F15	NC	-			PR14A	3	T	
J13	NC	-			PR13B	3	C	
H13	NC	-			PR13A	3	T	
H14	NC	-			PR12B	3	C	
G14	NC	-			PR12A	3	T	
E16	NC	-			PR11B	3	C	
E15	NC	-			PR11A	3	T	
H12	PR9B	2	C	PCLKC2_0	PR9B	2	C	PCLKC2_0
GND	GND2	2			GND2			
G12	PR9A	2	T	PCLKT2_0	PR9A	2	T	PCLKT2_0
G13	PR8B	2	C		PR8B	2	C	
F13	PR8A	2	T		PR8A	2	T	
F12	PR7B	2	C		PR7B	2	C	
E13	PR7A	2	T		PR7A	2	T	
D16	PR6B	2	C		PR6B	2	C	
D15	PR6A	2	T	RDQS6	PR6A	2	T	RDQS6
F14	PR5B	2	C		PR5B	2	C	
E14	PR5A	2	T		PR5A	2	T	

LFEC3 and LFECP/EC6 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFEC3				LFECP6/LFEC6			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
D7	PT11B	0	C		PT11B	0	C	
C7	PT11A	0	T		PT11A	0	T	
A7	PT10B	0	C		PT10B	0	C	
A6	PT10A	0	T		PT10A	0	T	
E7	PT9B	0	C		PT9B	0	C	
GND	GND0	0			GND0	0		
E6	PT9A	0	T		PT9A	0	T	
D6	PT8B	0	C		PT8B	0	C	
C6	PT8A	0	T		PT8A	0	T	
B6	PT7B	0	C		PT7B	0	C	
B5	PT7A	0	T		PT7A	0	T	
A5	PT6B	0	C		PT6B	0	C	
A4	PT6A	0	T	TDQS6	PT6A	0	T	TDQS6
A3	PT5B	0	C		PT5B	0	C	
A2	PT5A	0	T		PT5A	0	T	
B2	PT4B	0	C		PT4B	0	C	
B3	PT4A	0	T		PT4A	0	T	
D5	PT3B	0	C		PT3B	0	C	
C5	PT3A	0	T		PT3A	0	T	
C4	PT2B	0	C		PT2B	0	C	
B4	PT2A	0	T		PT2A	0	T	
GND	GND0	0			GND0	0		
A1	GND	-			GND	-		
A16	GND	-			GND	-		
G10	GND	-			GND	-		
G7	GND	-			GND	-		
G8	GND	-			GND	-		
G9	GND	-			GND	-		
H10	GND	-			GND	-		
H7	GND	-			GND	-		
H8	GND	-			GND	-		
H9	GND	-			GND	-		
J10	GND	-			GND	-		
J7	GND	-			GND	-		
J8	GND	-			GND	-		
J9	GND	-			GND	-		
K10	GND	-			GND	-		
K7	GND	-			GND	-		
K8	GND	-			GND	-		
K9	GND	-			GND	-		
T1	GND	-			GND	-		
T16	GND	-			GND	-		
E12	VCC	-			VCC	-		

LFEC6/EC6, LFEC6/EC10, LFEC6/EC15 Logic Signal Connections: 484 fpBGA

LFEC6/LFEC6					LFEC6/EC10					LFEC6/LFEC15				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
GND	GND7	7			GND	GND7	7			GND	GND7	7		
D4	PL2A	7	T	VREF2_7	D4	PL2A	7	T	VREF2_7	D4	PL2A	7	T	VREF2_7
E4	PL2B	7	C	VREF1_7	E4	PL2B	7	C	VREF1_7	E4	PL2B	7	C	VREF1_7
C3	NC	-			C3	PL3A	7	T		C3	PL3A	7	T	
B2	NC	-			B2	PL3B	7	C		B2	PL3B	7	C	
E5	NC	-			E5	PL4A	7	T		E5	PL4A	7	T	
F5	NC	-			F5	PL4B	7	C		F5	PL4B	7	C	
D3	NC	-			D3	PL5A	7	T		D3	PL5A	7	T	
C2	NC	-			C2	PL5B	7	C		C2	PL5B	7	C	
F4	NC	-			F4	PL6A	7	T	LDQS6	F4	PL6A	7	T	LDQS6
G4	NC	-			G4	PL6B	7	C		G4	PL6B	7	C	
E3	NC	-			E3	PL7A	7	T		E3	PL7A	7	T	
D2	NC	-			D2	PL7B	7	C		D2	PL7B	7	C	
B1	NC	-			B1	PL8A	7	T	LUM0_PLLT_IN_A	B1	PL8A	7	T	LUM0_PLLT_IN_A
C1	NC	-			C1	PL8B	7	C	LUM0_PLLC_IN_A	C1	PL8B	7	C	LUM0_PLLC_IN_A
F3	NC	-			F3	PL9A	7	T	LUM0_PLLT_FB_A	F3	PL9A	7	T	LUM0_PLLT_FB_A
GND	-	-			GND	GND7	7			GND	GND7	7		
E2	NC	-			E2	PL9B	7	C	LUM0_PLLC_FB_A	E2	PL9B	7	C	LUM0_PLLC_FB_A
G5	NC	-			G5	NC	-			G5	PL11A	7	T	
H6	NC	-			H6	NC	-			H6	PL11B	7	C	
G3	NC	-			G3	NC	-			G3	PL12A	7	T	
H4	NC	-			H4	NC	-			H4	PL12B	7	C	
J5	NC	-			J5	NC	-			J5	PL13A	7	T	
H5	NC	-			H5	NC	-			H5	PL13B	7	C	
F2	NC	-			F2	NC	-			F2	PL14A	7	T	
GND	-	-			GND	-	-			GND	GND7	7		
F1	NC	-			F1	NC	-			F1	PL14B	7	C	
E1	NC	-			E1	PL11A	7	T		E1	PL15A	7	T	
D1	NC	-			D1	PL11B	7	C		D1	PL15B	7	C	
H3	PL3A	7	T		H3	PL12A	7	T		H3	PL16A	7	T	
G2	PL3B	7	C		G2	PL12B	7	C		G2	PL16B	7	C	
H2	PL4A	7	T		H2	PL13A	7	T		H2	PL17A	7	T	
G1	PL4B	7	C		G1	PL13B	7	C		G1	PL17B	7	C	
J4	PL5A	7	T		J4	PL14A	7	T		J4	PL18A	7	T	
GND	-	-			GND	GND7	7			GND	GND7	7		
J3	PL5B	7	C		J3	PL14B	7	C		J3	PL18B	7	C	
J2	PL6A	7	T	LDQS6	J2	PL15A	7	T	LDQS15	J2	PL19A	7	T	LDQS19
H1	PL6B	7	C		H1	PL15B	7	C		H1	PL19B	7	C	
K4	PL7A	7	T		K4	PL16A	7	T		K4	PL20A	7	T	
K5	PL7B	7	C		K5	PL16B	7	C		K5	PL20B	7	C	
K3	PL8A	7	T		K3	PL17A	7	T		K3	PL21A	7	T	
K2	PL8B	7	C		K2	PL17B	7	C		K2	PL21B	7	C	
J1	PL9A	7	T	PCLKT7_0	J1	PL18A	7	T	PCLKT7_0	J1	PL22A	7	T	PCLKT7_0
GND	GND7	7			GND	GND7	7			GND	GND7	7		
K1	PL9B	7	C	PCLKC7_0	K1	PL18B	7	C	PCLKC7_0	K1	PL22B	7	C	PCLKC7_0
L3	XRES	6			L3	XRES	6			L3	XRES	6		
L4	PL11A	6	T		L4	PL20A	6	T		L4	PL24A	6	T	
L5	PL11B	6	C		L5	PL20B	6	C		L5	PL24B	6	C	
L2	PL12A	6	T		L2	PL21A	6	T		L2	PL25A	6	T	
L1	PL12B	6	C		L1	PL21B	6	C		L1	PL25B	6	C	

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
AF4	PB13B	5	C		AF4	PB13B	5	C	
AE5	PB14A	5	T	BDQS14	AE5	PB14A	5	T	BDQS14
AA9	PB14B	5	C		AA9	PB14B	5	C	
AF5	PB15A	5	T		AF5	PB15A	5	T	
Y10	PB15B	5	C		Y10	PB15B	5	C	
AD6	PB16A	5	T		AD6	PB16A	5	T	
AC10	PB16B	5	C		AC10	PB16B	5	C	
AF6	PB17A	5	T		AF6	PB17A	5	T	
GND	GND5	5			GND	GND5	5		
AE6	PB17B	5	C		AE6	PB17B	5	C	
AF7	PB18A	5	T		AF7	PB18A	5	T	
AB10	PB18B	5	C		AB10	PB18B	5	C	
AE7	PB19A	5	T		AE7	PB19A	5	T	
AD10	PB19B	5	C		AD10	PB19B	5	C	
AD7	PB20A	5	T		AD7	PB20A	5	T	
AA10	PB20B	5	C		AA10	PB20B	5	C	
AF8	PB21A	5	T		AF8	PB21A	5	T	
GND	GND5	5			GND	GND5	5		
AF9	PB21B	5	C		AF9	PB21B	5	C	
AD11	PB22A	5	T	BDQS22	AD11	PB22A	5	T	BDQS22
Y11	PB22B	5	C		Y11	PB22B	5	C	
AE8	PB23A	5	T		AE8	PB23A	5	T	
AC11	PB23B	5	C		AC11	PB23B	5	C	
AF10	PB24A	5	T		AF10	PB24A	5	T	
AB11	PB24B	5	C		AB11	PB24B	5	C	
AE10	PB25A	5	T		AE10	PB25A	5	T	
GND	GND5	5			GND	GND5	5		
AE9	PB25B	5	C		AE9	PB25B	5	C	
AA11	PB26A	5	T		AA11	PB26A	5	T	
Y12	PB26B	5	C		Y12	PB26B	5	C	
AE11	PB27A	5	T		AE11	PB27A	5	T	
AF11	PB27B	5	C		AF11	PB27B	5	C	
AF12	PB28A	5	T		AF12	PB28A	5	T	
AE12	PB28B	5	C		AE12	PB28B	5	C	
AD12	PB29A	5	T		AD12	PB29A	5	T	
GND	GND5	5			GND	GND5	5		
AC12	PB29B	5	C		AC12	PB29B	5	C	
AA12	PB30A	5	T	BDQS30	AA12	PB30A	5	T	BDQS30
AB12	PB30B	5	C		AB12	PB30B	5	C	
AE13	PB31A	5	T		AE13	PB31A	5	T	
AF13	PB31B	5	C		AF13	PB31B	5	C	
AD13	PB32A	5	T	VREF2_5	AD13	PB32A	5	T	VREF2_5

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
U21	PR36B	3	C		U21	PR48B	3	C	
T21	PR36A	3	T	RDQS36	T21	PR48A	3	T	RDQS48
T25	PR35B	3	C		T25	PR47B	3	C	
GND	GND3	3			GND	GND3	3		
T26	PR35A	3	T		T26	PR47A	3	T	
T22	PR34B	3	C		T22	PR46B	3	C	
T23	PR34A	3	T		T23	PR46A	3	T	
T24	PR33B	3	C		T24	PR45B	3	C	
R23	PR33A	3	T		R23	PR45A	3	T	
R25	PR32B	3	C		R25	PR44B	3	C	
R24	PR32A	3	T		R24	PR44A	3	T	
R26	PR31B	3	C		R26	PR43B	3	C	
GND	GND3	3			GND	GND3	3		
P26	PR31A	3	T		P26	PR43A	3	T	
R21	PR30B	3	C		R21	PR42B	3	C	
R22	PR30A	3	T		R22	PR42A	3	T	
P25	PR29B	3	C		P25	PR41B	3	C	
P24	PR29A	3	T		P24	PR41A	3	T	
P23	PR28B	3	C		P23	PR40B	3	C	
P22	PR28A	3	T	RDQS28	P22	PR40A	3	T	RDQS40
N26	PR27B	3	C		N26	PR39B	3	C	
GND	GND3	3			GND	GND3	3		
M26	PR27A	3	T		M26	PR39A	3	T	
N21	PR26B	3	C		N21	PR38B	3	C	
P21	PR26A	3	T		P21	PR38A	3	T	
N23	PR25B	3	C		N23	PR37B	3	C	
N22	PR25A	3	T		N22	PR37A	3	T	
N25	PR24B	3	C		N25	PR36B	3	C	
N24	PR24A	3	T		N24	PR36A	3	T	
L26	PR22B	2	C	PCLKC2_0	L26	PR34B	2	C	PCLKC2_0
GND	GND2	2			GND	GND2	2		
K26	PR22A	2	T	PCLKT2_0	K26	PR34A	2	T	PCLKT2_0
M22	PR21B	2	C		M22	PR33B	2	C	
M23	PR21A	2	T		M23	PR33A	2	T	
M25	PR20B	2	C		M25	PR32B	2	C	
M24	PR20A	2	T		M24	PR32A	2	T	
M21	PR19B	2	C		M21	PR31B	2	C	
L21	PR19A	2	T	RDQS19	L21	PR31A	2	T	RDQS31
L22	PR18B	2	C		L22	PR30B	2	C	
GND	GND2	2			GND	GND2	2		
L23	PR18A	2	T		L23	PR30A	2	T	
L25	PR17B	2	C		L25	PR29B	2	C	

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
U12	GND	-			U12	GND	-		
U13	GND	-			U13	GND	-		
U14	GND	-			U14	GND	-		
U15	GND	-			U15	GND	-		
U16	GND	-			U16	GND	-		
U17	GND	-			U17	GND	-		
H10	VCC	-			H10	VCC	-		
H11	VCC	-			H11	VCC	-		
H16	VCC	-			H16	VCC	-		
H17	VCC	-			H17	VCC	-		
H18	VCC	-			H18	VCC	-		
H19	VCC	-			H19	VCC	-		
H8	VCC	-			H8	VCC	-		
H9	VCC	-			H9	VCC	-		
J18	VCC	-			J18	VCC	-		
J9	VCC	-			J9	VCC	-		
K8	VCC	-			K8	VCC	-		
L19	VCC	-			L19	VCC	-		
M19	VCC	-			M19	VCC	-		
N7	VCC	-			N7	VCC	-		
R20	VCC	-			R20	VCC	-		
R7	VCC	-			R7	VCC	-		
T19	VCC	-			T19	VCC	-		
V18	VCC	-			V18	VCC	-		
V8	VCC	-			V8	VCC	-		
V9	VCC	-			V9	VCC	-		
W10	VCC	-			W10	VCC	-		
W11	VCC	-			W11	VCC	-		
W16	VCC	-			W16	VCC	-		
W17	VCC	-			W17	VCC	-		
W18	VCC	-			W18	VCC	-		
W19	VCC	-			W19	VCC	-		
W8	VCC	-			W8	VCC	-		
W9	VCC	-			W9	VCC	-		
H12	VCCIO0	0			H12	VCCIO0	0		
H13	VCCIO0	0			H13	VCCIO0	0		
J10	VCCIO0	0			J10	VCCIO0	0		
J11	VCCIO0	0			J11	VCCIO0	0		
J12	VCCIO0	0			J12	VCCIO0	0		
J13	VCCIO0	0			J13	VCCIO0	0		
H14	VCCIO1	1			H14	VCCIO1	1		
H15	VCCIO1	1			H15	VCCIO1	1		

Thermal Management

Thermal management is recommended as part of any sound FPGA design methodology. To assess the thermal characteristics of a system, Lattice specifies a maximum allowable junction temperature in all device data sheets. Designers must complete a thermal analysis of their specific design to ensure that the device and package do not exceed the junction temperature limits. Refer to the Thermal Management document to find the device/package specific thermal values.

For Further Information

For further information regarding Thermal Management, refer to the following located on the Lattice website at www.latticesemi.com.

- Thermal Management document
- Technical Note TN1052 - Power Estimation and Management for LatticeECP/EC and LatticeXP Devices
- Power Calculator tool included with Lattice's ispLEVER design tool, or as a standalone download from www.latticesemi.com/software